

SNOS792D-MAY 1999-REVISED MARCH 2013

# LM6172 Dual High Speed, Low Power, Low Distortion, Voltage Feedback Amplifiers

Check for Samples: LM6172

## **FEATURES**

- (Typical Unless Otherwise Noted)
- Easy to Use Voltage Feedback Topology
- High Slew Rate 3000V/µs
- Wide Unity-Gain Bandwidth 100MHz
- Low Supply Current 2.3mA/Channel
- High Output Current 50mA/channel
- Specified for ±15V and ±5V Operation

## **APPLICATIONS**

- Scanner I-to-V Converters
- **ADSL/HDSL Drivers**
- Multimedia Broadcast Systems
- **Video Amplifiers**
- NTSC, PAL and SECAM Systems

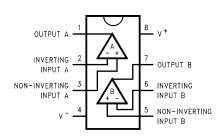
LM6172 Driving Capacitive Load

- **ADC/DAC Buffers**
- **Pulse Amplifiers and Peak Detectors**

# C<sub>1</sub> =150 pF 5V/div 5V/div C<sub>I</sub> =1000 pF

500ns

## Connection Diagram



#### Figure 1. Top View 8-Pin See Package Numbers P (PDIP) and D (SOIC)

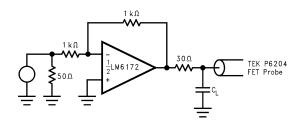
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#### DESCRIPTION

The LM6172 is a dual high speed voltage feedback amplifier. It is unity-gain stable and provides excellent DC and AC performance. With 100MHz unity-gain bandwidth, 3000V/µs slew rate and 50mA of output current per channel, the LM6172 offers high performance in dual amplifiers; yet it only consumes 2.3mA of supply current each channel.

The LM6172 operates on ±15V power supply for systems requiring large voltage swings, such as ADSL, scanners and ultrasound equipment. It is also specified at ±5V power supply for low voltage applications such as portable video systems.

The LM6172 is built with TI's advanced VIP III (Vertically Integrated PNP) complementary bipolar process. See the LM6171 datasheet for a single amplifier with these same features.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)(2)</sup>

| ESD Tolerance <sup>(3)</sup>                      | Human Body Model                        | 3kV  |  |  |
|---|---|--|--|--|
|   | Machine Model                           | 300V   |  |  |
| Supply Voltage (V <sup>+</sup> – V <sup>-</sup> ) |   | 36V  |  |  |
| Differential Input Voltage                        |   | ±10V   |  |  |
| Common Mode Voltage Range                         |   | V <sup>+</sup> +0.3V to V <sup>-</sup> -0.3V |  |  |
| Input Current                                     |   |  |  |  |
| Output Short Circuit to Ground <sup>(4)</sup>     |   | Continuous                                   |  |  |
| Storage Temp. Range                               |   | −65°C to +150°C                              |  |  |
| Maximum Junction Temperature <sup>(5)</sup>       |   | 150°C  |  |  |
| Soldering Information                             | Infrared or Convection Reflow (20 sec.) | 235°C  |  |  |
|   | Wave Soldering Lead Temp (10 sec.)      | 260°C  |  |  |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

- Human body model,  $1.5k\Omega$  in series with 100pF. Machine Model,  $200\Omega$  in series with 100pF. (3)
- Continuous short circuit operation can result in exceeding the maximum allowed junction temperature of 150°C. (4)
- The maximum power dissipation is a function of  $T_{J(max)}$ ,  $\tilde{\theta}_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(max)} T_A)/\theta_{JA}$ . All numbers apply for packages soldered directly into a PC board. (5)

#### Operating Ratings<sup>(1)</sup>

| Supply Voltage                        | $5.5V \le V_S \le 36V$ |                |
|---------------------------------------|------------------------|----------------|
| Operating Temperature Range           | LM6172I                | −40°C to +85°C |
| Thermal Resistance (θ <sub>JA</sub> ) | P Package, 8-Pin PDIP  | 95°C/W         |
|                                       | D Package, 8-Pin SOIC  | 160°C/W        |

Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for (1)which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

## ±15V DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for  $T_J = 25^{\circ}C$ ,  $V^+ = +15V$ ,  $V^- = -15V$ ,  $V_{CM} = 0V$ , and  $R_L = 1k\Omega$ . Boldface limits apply at the temperature extremes

| Symbol             | Parameter                          | Conditions        | Тур<br>(1) | LM6172I<br>Limit<br>(2) | Units |
|--------------------|------------------------------------|-------------------|------------|-------------------------|-------|
| V <sub>OS</sub>    | Input Offset Voltage               |                   | 0.4        | 3                       | mV    |
|                    |                                    |                   |            | 4                       | max   |
| TC V <sub>OS</sub> | Input Offset Voltage Average Drift |                   | 6          |                         | µV/°C |
| I <sub>B</sub>     | Input Bias Current                 |                   | 1.2        | 3                       | μA    |
|                    |                                    |                   |            | 4                       | max   |
| l <sub>os</sub>    | Input Offset Current               |                   | 0.02       | 2                       | μA    |
|                    |                                    |                   |            | 3                       | max   |
| R <sub>IN</sub>    | Input Resistance                   | Common Mode       | 40         |                         | MO    |
|                    |                                    | Differential Mode | 4.9        |                         | MΩ    |
| R <sub>O</sub>     | Open Loop Output Resistance        |                   | 14         |                         | Ω     |

Typical Values represent the most likely parametric normal. (1)

All limits are guaranteed by testing or statistical analysis. (2)



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## ±15V DC Electrical Characteristics (continued)

Unless otherwise specified, all limits guaranteed for  $T_J = 25^{\circ}C$ ,  $V^+ = +15V$ ,  $V^- = -15V$ ,  $V_{CM} = 0V$ , and  $R_L = 1k\Omega$ . **Boldface** limits apply at the temperature extremes

| Symbol          | Parameter                                | Conditions                    | Тур<br>(1) | LM6172I<br>Limit<br>(2) | Units |
|-----------------|--|-------------------------------|------------|-------------------------|-------|
| CMRR            | Common Mode Rejection Ratio              | $V_{CM} = \pm 10V$            | 110        | 70                      | dB    |
|                 |  |                               |            | 65                      | min   |
| PSRR            | Power Supply Rejection Ratio             | $V_{S} = \pm 15V$ to $\pm 5V$ | 95         | 75                      | dB    |
|                 |  |                               |            | 70                      | min   |
| V <sub>CM</sub> | Input Common Mode Voltage Range          | CMRR ≥ 60dB                   | ±13.5      |                         | V     |
| A <sub>V</sub>  | Large Signal Voltage Gain <sup>(3)</sup> | $R_L = 1k\Omega$              | 86         | 80                      | dB    |
|                 |  |                               |            | 75                      | min   |
|                 |  | R <sub>L</sub> = 100Ω         | 78         | 65                      | dB    |
|                 |  |                               |            | 60                      | min   |
| Vo              | Output Swing                             | $R_L = 1k\Omega$              | 13.2       | 12.5                    | V     |
|                 |  |                               |            | 12                      | min   |
|                 |  |                               | -13.1      | -12.5                   | V     |
|                 |  |                               |            | -12                     | max   |
|                 |  | R <sub>L</sub> = 100Ω         | 9          | 6                       | V     |
|                 |  |                               |            | 5                       | min   |
|                 |  |                               | -8.5       | -6                      | V     |
|                 |  |                               |            | -5                      | max   |
|                 | Continuous Output Current                | Sourcing, $R_L = 100\Omega$   | 90         | 60                      | mA    |
|                 |  |                               |            | 50                      | min   |
|                 | (Open Loop) <sup>(4)</sup>               | Sinking, $R_L = 100\Omega$    | -85        | -60                     | mA    |
|                 |  |                               |            | -50                     | max   |
| SC              |  | Sourcing                      | 107        |                         | mA    |
|                 | Current Output Short Circuit             | Sinking                       | -105       |                         | mA    |
| S               | Supply Current                           | Both Amplifiers               | 4.6        | 8                       | mA    |
|                 |  |                               |            | 9                       | max   |

(3) Large signal voltage gain is the total output swing divided by the input signal required to produce that swing. For  $V_S = \pm 15V$ ,  $V_{OUT} = \pm 5V$ . For  $V_S = \pm 5V$ ,  $V_{OUT} = \pm 1V$ .

(4) The open loop output current is the output swing with the  $100\Omega$  load resistor divided by that resistor.

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#### ±15V AC Electrical Characteristics

Unless otherwise specified,  $T_J = 25^{\circ}C$ ,  $V^+ = +15V$ ,  $V^- = -15V$ ,  $V_{CM} = 0V$ , and  $R_L = 1k\Omega$ 

| Symbol         | Parameter                           | Conditions                        | LM6172I<br>Typ<br>⑴ | Units  |
|----------------|-------------------------------------|-----------------------------------|---------------------|--------|
| SR             | Slew Rate                           | $A_V = +2, V_{IN} = 13 V_{PP}$    | 3000                | V/µs   |
|                |                                     | $A_V = +2$ , $V_{IN} = 10 V_{PP}$ | 2500                | V/µs   |
|                | Unity-Gain Bandwidth                |                                   | 100                 | MHz    |
|                | -3 dB Frequency                     | A <sub>V</sub> = +1               | 160                 | MHz    |
|                |                                     | A <sub>V</sub> = +2               | 62                  | MHz    |
|                | Bandwidth Matching between Channels |                                   | 2                   | MHz    |
| φ <sub>m</sub> | Phase Margin                        |                                   | 40                  | Deg    |
| t <sub>s</sub> | Settling Time (0.1%)                |                                   | 65                  | ns     |
| A <sub>D</sub> | Differential Gain <sup>(2)</sup>    |                                   | 0.28                | %      |
| Φ <sub>D</sub> | Differential Phase <sup>(2)</sup>   |                                   | 0.6                 | Deg    |
| e <sub>n</sub> | Input-Referred Voltage Noise        | f = 1kHz                          | 12                  | nV/√Hz |
| i <sub>n</sub> | Input-Referred Current Noise        | f = 1kHz                          | 1                   | pA/√Hz |
|                | Second Harmonic                     | f = 10kHz                         | -110                | dB     |
|                | Distortion <sup>(3)</sup>           | f = 5MHz                          | -50                 | dB     |
|                | Third Harmonic                      | f = 10kHz                         | -105                | dB     |
|                | Distortion <sup>(3)</sup>           | f = 5MHz                          | -50                 | dB     |

Typical Values represent the most likely parametric normal.
Differential gain and phase are measured with A<sub>V</sub> = +2, V<sub>IN</sub> = 1 V<sub>PP</sub> at 3.58MHz and both input and output 75Ω terminated.
Harmonics are measured with A<sub>V</sub> = +2, V<sub>IN</sub> = 1 V<sub>PP</sub> and R<sub>L</sub> = 100Ω.



#### ±5V DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for  $T_J = 25^{\circ}C$ ,  $V^+ = +5V$ ,  $V^- = -5V$ ,  $V_{CM} = 0V$ , and  $R_L = 1 \text{ k}\Omega$ . Boldface limits apply at the temperature extremes

| Symbol             | Parameter                                | Conditions                    | Typ<br>(1) | LM6172I<br>Limit | Units |
|--------------------|--|-------------------------------|------------|------------------|-------|
| V <sub>OS</sub>    | Input Offset Voltage                     |                               | 0.1        | 3                | mV    |
|                    |  |                               |            | 4                | max   |
| TC V <sub>OS</sub> | Input Offset Voltage Average Drift       |                               | 4          |                  | µV/°C |
| I <sub>B</sub>     | Input Bias Current                       |                               | 1.4        | 2.5              | μA    |
|                    |  |                               |            | 3.5              | max   |
| l <sub>os</sub>    | Input Offset Current                     |                               | 0.02       | 1.5              | μA    |
|                    |  |                               |            | 2.2              | max   |
| R <sub>IN</sub>    | Input Resistance                         | Common Mode                   | 40         |                  | ΜΩ    |
|                    |  | Differential Mode             | 4.9        |                  | IVIS2 |
| R <sub>O</sub>     | Output Resistance                        |                               | 14         |                  | Ω     |
| CMRR               | Common Mode Rejection Ratio              | $V_{CM} = \pm 2.5 V$          | 105        | 70               | dB    |
|                    |  |                               |            | 65               | min   |
| PSRR               | Power Supply Rejection Ratio             | $V_{S} = \pm 15V$ to $\pm 5V$ | 95         | 75               | dB    |
|                    |  |                               |            | 70               | min   |
| V <sub>CM</sub>    | Input Common Mode Voltage Range          | CMRR ≥ 60dB                   | ±3.7       |                  | V     |
| A <sub>V</sub>     | Large Signal Voltage Gain <sup>(3)</sup> | $R_L = 1k\Omega$              | 82         | 70               | dB    |
|                    |  |                               |            | 65               | min   |
|                    |  | R <sub>L</sub> = 100Ω         | 78         | 65               | dB    |
|                    |  |                               |            | 60               | min   |
| Vo                 | Output Swing                             | $R_L = 1k\Omega$              | 3.4        | 3.1              | V     |
|                    |  |                               |            | 3                | min   |
|                    |  |                               | -3.3       | -3.1             | V     |
|                    |  |                               |            | -3               | max   |
|                    |  | R <sub>L</sub> = 100Ω         | 2.9        | 2.5              | V     |
|                    |  |                               |            | 2.4              | min   |
|                    |  |                               | -2.7       | -2.4             | V     |
|                    |  |                               |            | -2.3             | max   |
|                    | Continuous Output Current (Open          | Sourcing, $R_L = 100\Omega$   | 29         | 25               | mA    |
|                    | Loop) <sup>(4)</sup>                     |                               |            | 24               | min   |
|                    |  | Sinking, $R_L = 100\Omega$    | -27        | -24              | mA    |
|                    |  |                               |            | -23              | max   |
| I <sub>SC</sub>    | Output Short Circuit Current             | Sourcing                      | 93         |                  | mA    |
|                    |  | Sinking                       | -72        |                  | mA    |
| ls                 | Supply Current                           | Both Amplifiers               | 4.4        | 6                | mA    |
|                    |  |                               |            | 7                | max   |

Typical Values represent the most likely parametric normal.
All limits are guaranteed by testing or statistical analysis.

(3) Large signal voltage gain is the total output swing divided by the input signal required to produce that swing. For V<sub>S</sub> = ±15V, V<sub>OUT</sub> =  $\pm$ 5V. For V<sub>S</sub> =  $\pm$ 5V, V<sub>OUT</sub> =  $\pm$ 1V.

(4) The open loop output current is the output swing with the  $100\Omega$  load resistor divided by that resistor.

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#### ±5V AC Electrical Characteristics

Unless otherwise specified,  $T_J = 25^{\circ}C$ ,  $V^+ = +5V$ ,  $V^- = -5V$ ,  $V_{CM} = 0V$ , and  $R_L = 1 \text{ k}\Omega$ .

| Symbol         | Parameter                                 | Conditions                                    | LM61722<br>Typ<br>(1) | Units  |
|----------------|---|---|-----------------------|--------|
| SR             | Slew Rate                                 | $A_V = +2, V_{IN} = 3.5 V_{PP}$               | 750                   | V/µs   |
|                | Unity-Gain Bandwidth                      |   | 70                    | MHz    |
|                | -3 dB Frequency                           | A <sub>V</sub> = +1                           | 130                   | MHz    |
|                |   | A <sub>V</sub> = +2                           | 45                    | MHz    |
| φ <sub>m</sub> | Phase Margin                              |   | 57                    | Deg    |
| t <sub>s</sub> | Settling Time (0.1%)                      | $A_V = -1, V_{OUT} = \pm 1V, R_L = 500\Omega$ | 72                    | ns     |
| A <sub>D</sub> | Differential Gain <sup>(2)</sup>          |   | 0.4                   | %      |
| φ <sub>D</sub> | Differential Phase <sup>(2)</sup>         |   | 0.7                   | Deg    |
| e <sub>n</sub> | Input-Referred Voltage Noise              | f = 1kHz                                      | 11                    | nV/√Hz |
| i <sub>n</sub> | Input-Referred Current Noise              | f = 1kHz                                      | 1                     | pA/√Hz |
|                | Second Harmonic Distortion <sup>(3)</sup> | f = 10kHz                                     | -110                  | dB     |
|                |   | f = 5MHz                                      | -48                   | dB     |
|                | Third Harmonic Distortion <sup>(3)</sup>  | f = 10kHz                                     | -105                  | dB     |
|                |   | f = 5MHz                                      | -50                   | dB     |

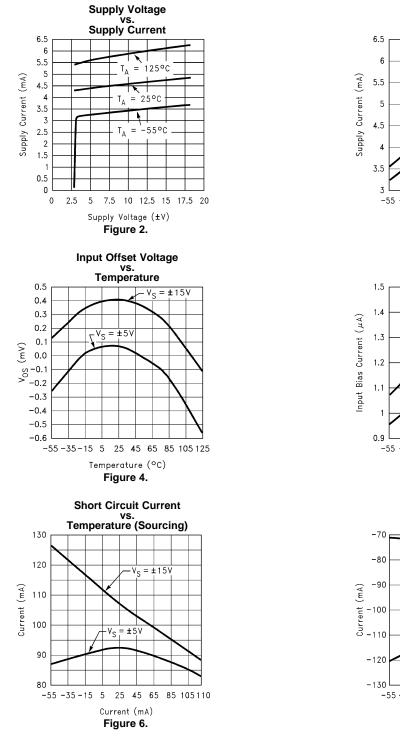
(1)

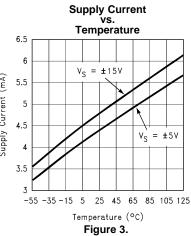
Typical Values represent the most likely parametric normal. Differential gain and phase are measured with  $A_V = +2$ ,  $V_{IN} = 1$   $V_{PP}$  at 3.58MHz and both input and output 75 $\Omega$  terminated. Harmonics are measured with  $A_V = +2$ ,  $V_{IN} = 1$   $V_{PP}$  and  $R_L = 100\Omega$ . (2) (3)

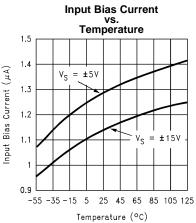


#### **Typical Performance Characteristics**

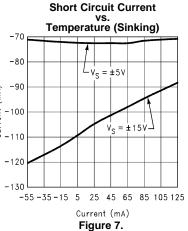
unless otherwise noted,  $T_A = 25^{\circ}C$ 



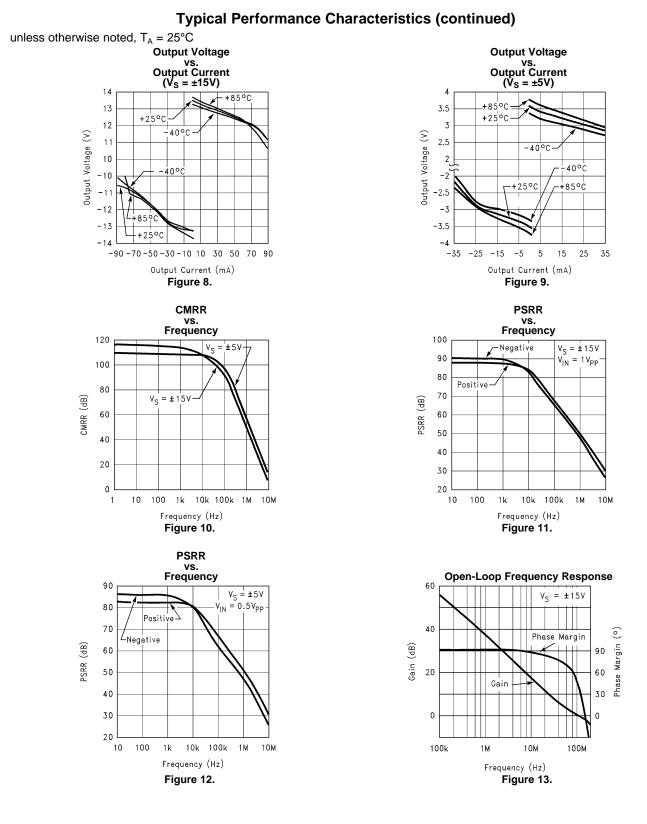








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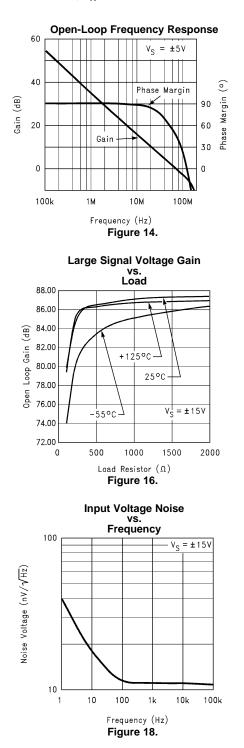


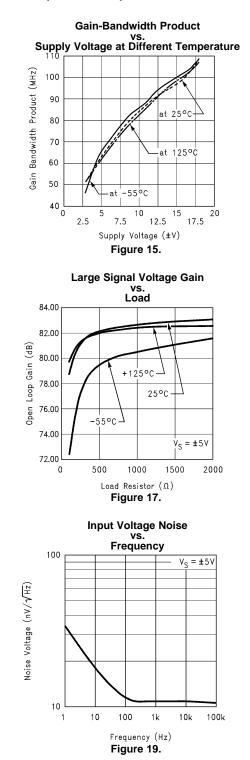


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#### **Typical Performance Characteristics (continued)**

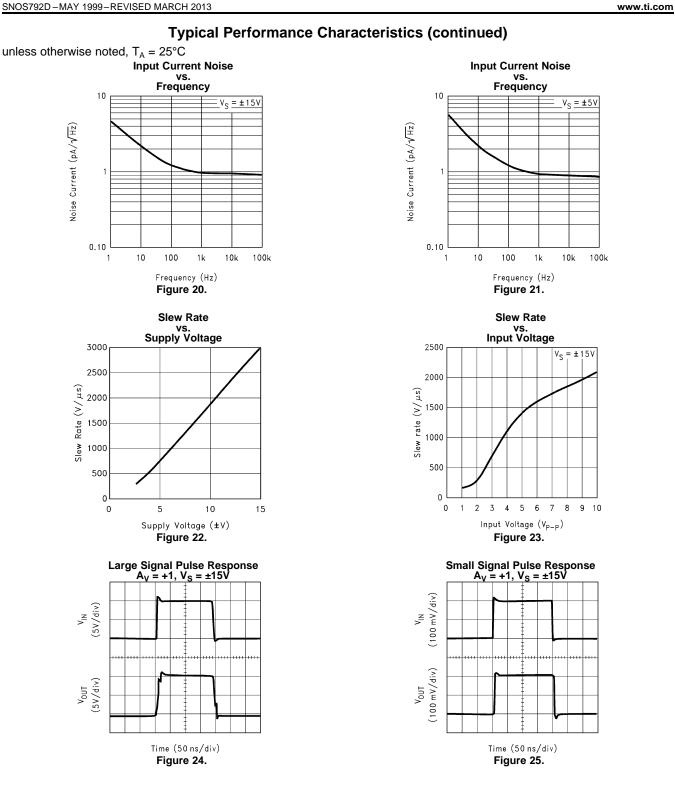
unless otherwise noted,  $T_A = 25^{\circ}C$ 





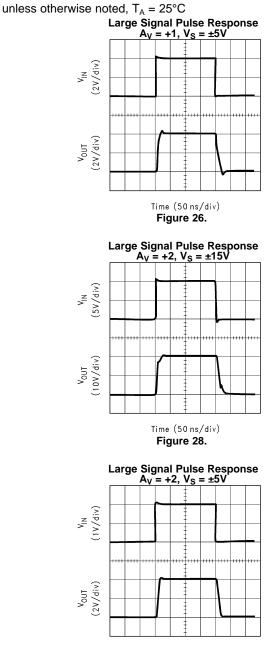
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Time (50 ns/div) Figure 30.

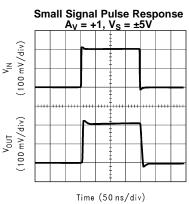
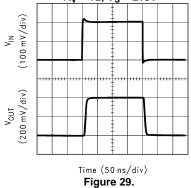
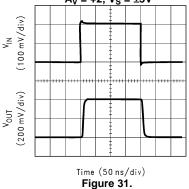


Figure 27.

 $\frac{\text{Small Signal Pulse Response}}{A_V = +2, V_S = \pm 15V}$ 

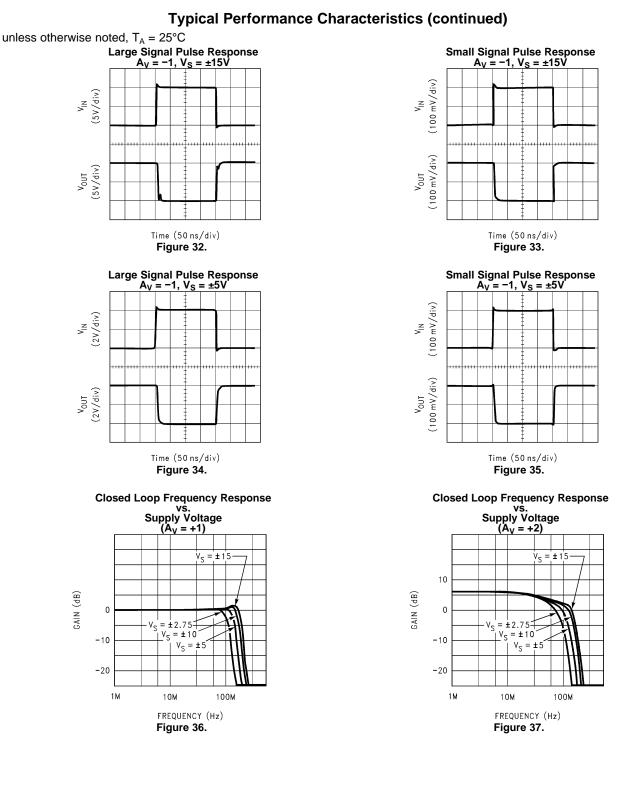


Small Signal Pulse Response  $A_V = +2$ ,  $V_S = \pm 5V$ 





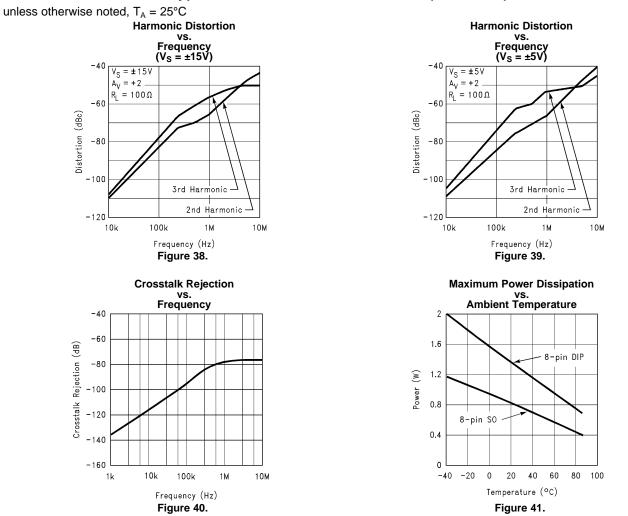
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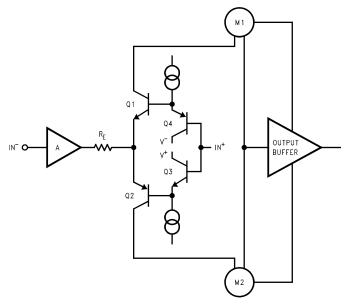


Figure 42.

#### **APPLICATION NOTES**

#### LM6172 PERFORMANCE DISCUSSION

The LM6172 is a dual high-speed, low power, voltage feedback amplifier. It is unity-gain stable and offers outstanding performance with only 2.3mA of supply current per channel. The combination of 100MHz unity-gain bandwidth,  $3000V/\mu$ s slew rate, 50mA per channel output current and other attractive features makes it easy to implement the LM6172 in various applications. Quiescent power of the LM6172 is 138mW operating at ±15V supply and 46mW at ±5V supply.

#### LM6172 CIRCUIT OPERATION

The class AB input stage in LM6172 is fully symmetrical and has a similar slewing characteristic to the current feedback amplifiers. In Figure 42, Q1 through Q4 form the equivalent of the current feedback input buffer,  $R_E$  the equivalent of the feedback resistor, and stage A buffers the inverting input. The triple-buffered output stage isolates the gain stage from the load to provide low output impedance.

#### LM6172 SLEW RATE CHARACTERISTIC

The slew rate of LM6172 is determined by the current available to charge and discharge an internal high impedance node capacitor. This current is the differential input voltage divided by the total degeneration resistor  $R_E$ . Therefore, the slew rate is proportional to the input voltage level, and the higher slew rates are achievable in the lower gain configurations.

When a very fast large signal pulse is applied to the input of an amplifier, some overshoot or undershoot occurs. By placing an external series resistor such as  $1k\Omega$  to the input of LM6172, the slew rate is reduced to help lower the overshoot, which reduces settling time.

#### **REDUCING SETTLING TIME**

The LM6172 has a very fast slew rate that causes overshoot and undershoot. To reduce settling time on LM6172, a  $1k\Omega$  resistor can be placed in series with the input signal to decrease slew rate. A feedback capacitor can also be used to reduce overshoot and undershoot. This feedback capacitor serves as a zero to increase the stability of the amplifier circuit. A 2pF feedback capacitor is recommended for initial evaluation. When the LM6172 is configured as a buffer, a feedback resistor of  $1k\Omega$  must be added in parallel to the feedback capacitor.



Another possible source of overshoot and undershoot comes from capacitive load at the output. Please see DRIVING CAPACITIVE LOADS for more detail.

#### DRIVING CAPACITIVE LOADS

Amplifiers driving capacitive loads can oscillate or have ringing at the output. To eliminate oscillation or reduce ringing, an isolation resistor can be placed as shown in Figure 43. The combination of the isolation resistor and the load capacitor forms a pole to increase stability by adding more phase margin to the overall system. The desired performance depends on the value of the isolation resistor; the bigger the isolation resistor, the more damped (slow) the pulse response becomes. For LM6172, a  $50\Omega$  isolation resistor is recommended for initial evaluation.

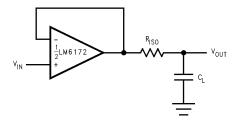


Figure 43. Isolation Resistor Used to Drive Capacitive Load

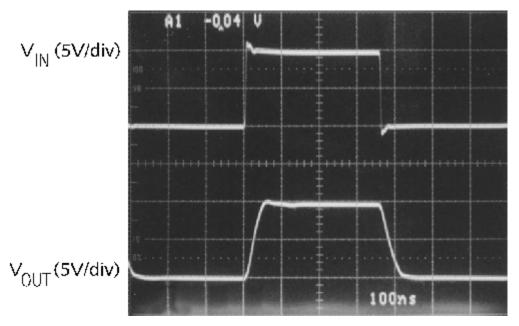


Figure 44. The LM6172 Driving a 510pF Load with a 30 $\Omega$  Isolation Resistor

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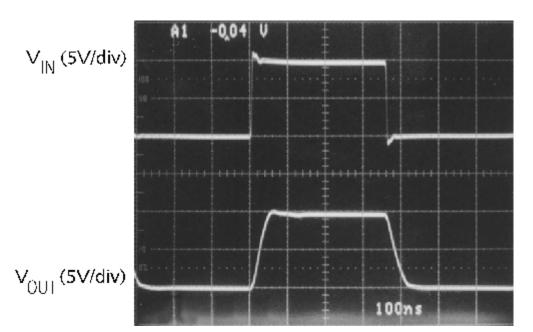


Figure 45. The LM6172 Driving a 220 pF Load with a 50Ω Isolation Resistor

## LAYOUT CONSIDERATION

#### PRINTED CIRCUIT BOARDS AND HIGH SPEED OP AMPS

There are many things to consider when designing PC boards for high speed op amps. Without proper caution, it is very easy to have excessive ringing, oscillation and other degraded AC performance in high speed circuits. As a rule, the signal traces should be short and wide to provide low inductance and low impedance paths. Any unused board space needs to be grounded to reduce stray signal pickup. Critical components should also be grounded at a common point to eliminate voltage drop. Sockets add capacitance to the board and can affect frequency performance. It is better to solder the amplifier directly into the PC board without using any socket.

#### USING PROBES

Active (FET) probes are ideal for taking high frequency measurements because they have wide bandwidth, high input impedance and low input capacitance. However, the probe ground leads provide a long ground loop that will produce errors in measurement. Instead, the probes can be grounded directly by removing the ground leads and probe jackets and using scope probe jacks.

#### COMPONENTS SELECTION AND FEEDBACK RESISTOR

It is important in high speed applications to keep all component leads short because wires are inductive at high frequency. For discrete components, choose carbon composition-type resistors and mica-type capacitors. Surface mount components are preferred over discrete components for minimum inductive effect.

Large values of feedback resistors can couple with parasitic capacitance and cause undesirable effects such as ringing or oscillation in high speed amplifiers. For LM6172, a feedback resistor less than  $1k\Omega$  gives optimal performance.

## COMPENSATION FOR INPUT CAPACITANCE

The combination of an amplifier's input capacitance with the gain setting resistors adds a pole that can cause peaking or oscillation. To solve this problem, a feedback capacitor with a value

$$C_F > (R_G \times C_{IN})/R_F$$

(1)

can be used to cancel that pole. For LM6172, a feedback capacitor of 2pF is recommended. Figure 46 illustrates the compensation circuit.



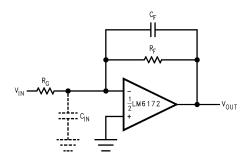


Figure 46. Compensating for Input Capacitance

#### POWER SUPPLY BYPASSING

Bypassing the power supply is necessary to maintain low power supply impedance across frequency. Both positive and negative power supplies should be bypassed individually by placing 0.01µF ceramic capacitors directly to power supply pins and 2.2µF tantalum capacitors close to the power supply pins.

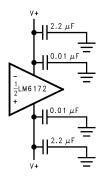


Figure 47. Power Supply Bypassing

#### TERMINATION

In high frequency applications, reflections occur if signals are not properly terminated. Figure 48 shows a properly terminated signal while Figure 49 shows an improperly terminated signal.



SNOS792D-MAY 1999-REVISED MARCH 2013

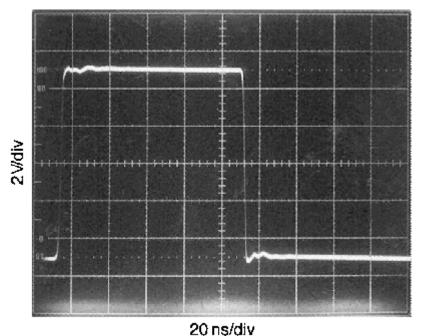
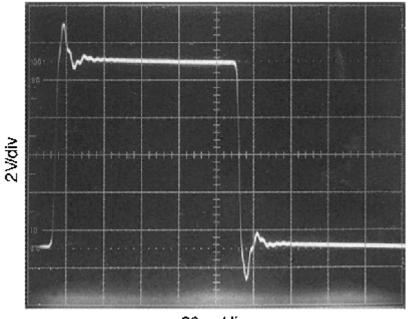


Figure 48. Properly Terminated Signal



20 ns/div Figure 49. Improperly Terminated Signal

To minimize reflection, coaxial cable with matching characteristic impedance to the signal source should be used. The other end of the cable should be terminated with the same value terminator or resistor. For the commonly used cables, RG59 has  $75\Omega$  characteristic impedance, and RG58 has  $50\Omega$  characteristic impedance.

#### POWER DISSIPATION

The maximum power allowed to dissipate in a device is defined as:

 $\mathsf{P}_\mathsf{D} = (\mathsf{T}_\mathsf{J(max)} - \mathsf{T}_\mathsf{A})/\theta_\mathsf{JA}$ 



(2)

#### Where

- P<sub>D</sub> is the power dissipation in a device
- T<sub>J(max)</sub> is the maximum junction temperature
- T<sub>A</sub> is the ambient temperature
- $\theta_{JA}$  is the thermal resistance of a particular package

For example, for the LM6172 in a SOIC-8 package, the maximum power dissipation at 25°C ambient temperature is 780mW.

Thermal resistance,  $\theta_{JA}$ , depends on parameters such as die size, package size and package material. The smaller the die size and package, the higher  $\theta_{JA}$  becomes. The 8-pin DIP package has a lower thermal resistance (95°C/W) than that of 8-pin SO (160°C/W). Therefore, for higher dissipation capability, use an 8-pin DIP package.

The total power dissipated in a device can be calculated as:  $P_D = P_O + P_L$ 

 $P_Q$  is the quiescent power dissipated in a device with no load connected at the output.  $P_L$  is the power dissipated in the device with a load connected at the output; it is not the power dissipated by the load.

Furthermore,

 $P_{Q}$  = supply current x total supply voltage with no load

 $P_L$  = output current x (voltage difference between supply voltage and output voltage of the same supply)

For example, the total power dissipated by the LM6172 with  $V_S = \pm 15V$  and both channels swinging output voltage of 10V into 1k $\Omega$  is

$$\mathbf{P}_{\mathbf{D}} = \mathbf{P}_{\mathbf{Q}} + \mathbf{P}_{\mathbf{L}}$$

- = 2[(2.3mA)(30V)] + 2[(10mA)(15V 10V)]
- = 138mW + 100mW
- = 238mW

#### **Application Circuits**

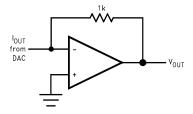


Figure 50. I-to-V Converters

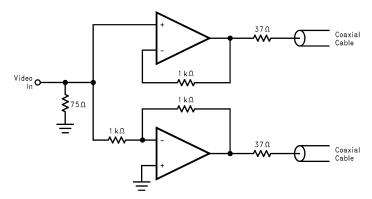


Figure 51. Differential Line Driver

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#### **REVISION HISTORY**

| Cł | Changes from Revision C (March 2013) to Revision D P |    |  |  |  |  |  |  |
|----|--|----|--|--|--|--|--|--|
| •  | Changed layout of National Data Sheet to TI format   | 19 |  |  |  |  |  |  |

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## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)         | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-------------------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| LM6172IM         | NRND          | SOIC         | D                  | 8    | 95             | Non-RoHS &<br>Non-Green | Call TI                              | Call TI              | -40 to 85    | LM61<br>72IM            |         |
| LM6172IM/NOPB    | ACTIVE        | SOIC         | D                  | 8    | 95             | RoHS & Green            | SN                                   | Level-1-260C-UNLIM   | -40 to 85    | LM61<br>72IM            | Samples |
| LM6172IMX        | NRND          | SOIC         | D                  | 8    | 2500           | Non-RoHS &<br>Non-Green | Call TI                              | Call TI              | -40 to 85    | LM61<br>72IM            |         |
| LM6172IMX/NOPB   | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green            | SN                                   | Level-1-260C-UNLIM   | -40 to 85    | LM61<br>72IM            | Samples |
| LM6172IN/NOPB    | ACTIVE        | PDIP         | Р                  | 8    | 40             | RoHS & Green            | Call TI   SN                         | Level-1-NA-UNLIM     | -40 to 85    | LM6172IN                | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



10-Dec-2020

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# PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |   |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| LM6172IMX                   | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.5        | 5.4        | 2.0        | 8.0        | 12.0      | Q1               |
| LM6172IMX/NOPB              | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.5        | 5.4        | 2.0        | 8.0        | 12.0      | Q1               |

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# PACKAGE MATERIALS INFORMATION

29-Sep-2019



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM6172IMX      | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LM6172IMX/NOPB | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |

# D0008A



# **PACKAGE OUTLINE**

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



# D0008A

# **EXAMPLE BOARD LAYOUT**

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# D0008A

# **EXAMPLE STENCIL DESIGN**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



P(R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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